

# International IOR Rectifier

## IRG4IBC20WPbF

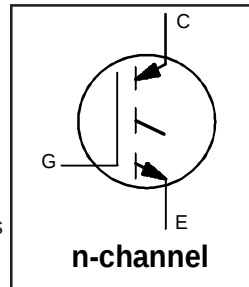
### INSULATED GATE BIPOLAR TRANSISTOR

#### Features

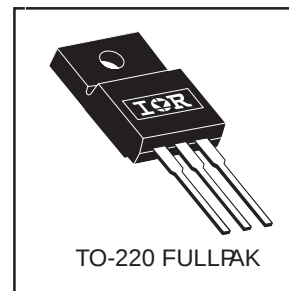
- Designed expressly for Switch-Mode Power Supply and PFC (power factor correction) applications
- 2.5kV, 60s insulation voltage ⑥
- Industry-benchmark switching losses improve efficiency of all power supply topologies
- 50% reduction of Eoff parameter
- Low IGBT conduction losses
- Latest-generation IGBT design and construction offers tighter parameters distribution, exceptional reliability
- Industry standard Isolated TO-220 Fullpak™ outline
- Lead-Free

#### Benefits

- Lower switching losses allow more cost-effective operation than power MOSFETs up to 150 kHz ("hard switched" mode)
- Of particular benefit to single-ended converters and boost PFC topologies 150W and higher
- Low conduction losses and minimal minority-carrier recombination make these an excellent option for resonant mode switching as well (up to >>300 kHz)



|                                   |
|-----------------------------------|
| $V_{CES} = 600V$                  |
| $V_{CE(on)} \text{ typ.} = 2.16V$ |
| @ $V_{GE} = 15V, I_C = 6.5A$      |



#### Absolute Maximum Ratings

|                           | Parameter                              | Max.                               | Units      |
|---------------------------|----------------------------------------|------------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Breakdown Voltage | 600                                | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current           | 11.8                               | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current           | 6.2                                |            |
| $I_{CM}$                  | Pulsed Collector Current ①             | 52                                 |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②       | 52                                 |            |
| $V_{GE}$                  | Gate-to-Emitter Voltage                | $\pm 20$                           | V          |
| $E_{ARV}$                 | Reverse Voltage Avalanche Energy ③     | 200                                | mJ         |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation              | 34                                 | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation              | 14                                 |            |
| $T_J$                     | Operating Junction and                 | -55 to + 150                       | $^\circ C$ |
| $T_{STG}$                 | Storage Temperature Range              |                                    |            |
|                           | Soldering Temperature, for 10 seconds  | 300 (0.063 in. (1.6mm) from case ) |            |
|                           | Mounting torque, 6-32 or M3 screw.     | 10 lbf•in (1.1N•m)                 |            |

#### Thermal Resistance

|                 | Parameter                                 | Typ.       | Max. | Units        |
|-----------------|-------------------------------------------|------------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | —          | 3.7  | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —          | 65   |              |
| Wt              | Weight                                    | 2.0 (0.07) | —    | g (oz)       |

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

|                                 | Parameter                                | Min. | Typ. | Max.      | Units                | Conditions                                            |
|---------------------------------|------------------------------------------|------|------|-----------|----------------------|-------------------------------------------------------|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage   | 600  | —    | —         | V                    | $V_{GE} = 0V, I_C = 250\mu A$                         |
| $V_{(BR)ECS}$                   | Emitter-to-Collector Breakdown Voltage ④ | 18   | —    | —         | V                    | $V_{GE} = 0V, I_C = 1.0A$                             |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage  | —    | 0.48 | —         | V/ $^\circ\text{C}$  | $V_{GE} = 0V, I_C = 1.0mA$                            |
| $V_{CE(ON)}$                    | Collector-to-Emitter Saturation Voltage  | —    | 2.16 | 2.6       | V                    | $I_C = 6.5A, V_{GE} = 15V$                            |
|                                 |                                          | —    | 2.55 | —         |                      | $I_C = 13A, V_{GE} = 15V$                             |
|                                 |                                          | —    | 2.05 | —         |                      | $I_C = 6.5A, T_J = 150^\circ\text{C}$<br>See Fig.2, 5 |
| $V_{GE(th)}$                    | Gate Threshold Voltage                   | 3.0  | —    | 6.0       |                      | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage  | —    | -8.8 | —         | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $g_{fe}$                        | Forward Transconductance ⑤               | 5.5  | 8.3  | —         | S                    | $V_{CE} = 100V, I_C = 6.5A$                           |
| $I_{CES}$                       | Zero Gate Voltage Collector Current      | —    | —    | 250       | $\mu A$              | $V_{GE} = 0V, V_{CE} = 600V$                          |
|                                 |                                          | —    | —    | 2.0       |                      | $V_{GE} = 0V, V_{CE} = 10V, T_J = 25^\circ\text{C}$   |
|                                 |                                          | —    | —    | 1000      |                      | $V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current          | —    | —    | $\pm 100$ | nA                   | $V_{GE} = \pm 20V$                                    |

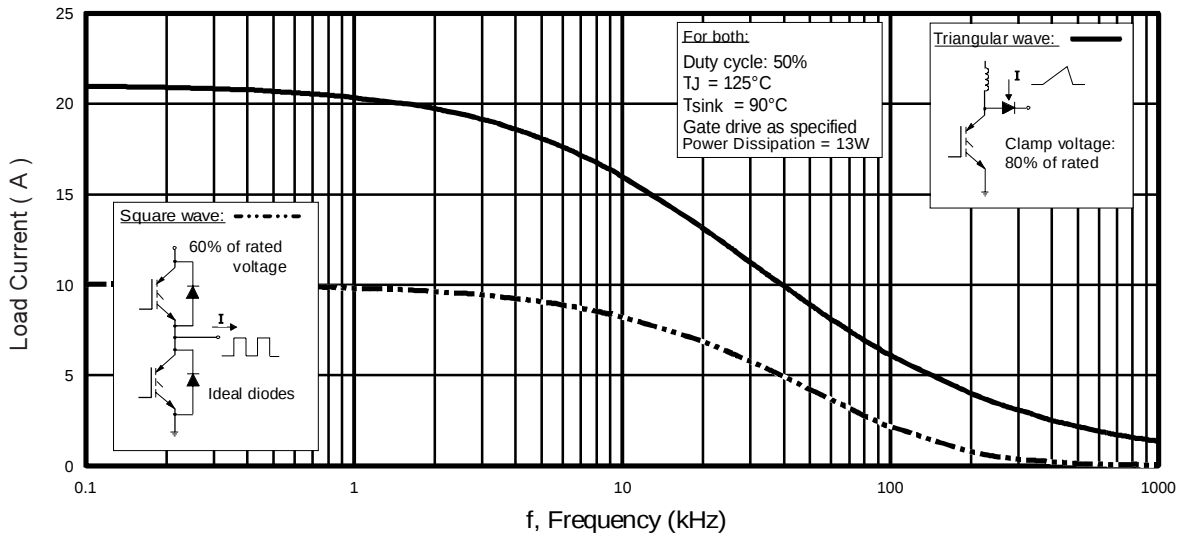
## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

|                     | Parameter                         | Min. | Typ. | Max. | Units | Conditions                                                                                                                                                                     |
|---------------------|-----------------------------------|------|------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Q <sub>g</sub>      | Total Gate Charge (turn-on)       | —    | 26   | 38   | nC    | I <sub>C</sub> = 6.5A<br>V <sub>CC</sub> = 400V<br>V <sub>GE</sub> = 15V<br>See Fig.8                                                                                          |
| Q <sub>ge</sub>     | Gate - Emitter Charge (turn-on)   | —    | 3.7  | 5.5  |       |                                                                                                                                                                                |
| Q <sub>gc</sub>     | Gate - Collector Charge (turn-on) | —    | 10   | 15   |       |                                                                                                                                                                                |
| t <sub>d(on)</sub>  | Turn-On Delay Time                | —    | 22   | —    | ns    | T <sub>J</sub> = 25°C<br>I <sub>C</sub> = 6.5A, V <sub>CC</sub> = 480V<br>V <sub>GE</sub> = 15V, R <sub>G</sub> = 50Ω<br>Energy losses include "tail"<br>See Fig. 9, 10, 14    |
| t <sub>r</sub>      | Rise Time                         | —    | 14   | —    |       |                                                                                                                                                                                |
| t <sub>d(off)</sub> | Turn-Off Delay Time               | —    | 110  | 160  |       |                                                                                                                                                                                |
| t <sub>f</sub>      | Fall Time                         | —    | 64   | 96   | mJ    |                                                                                                                                                                                |
| E <sub>on</sub>     | Turn-On Switching Loss            | —    | 0.06 | —    |       |                                                                                                                                                                                |
| E <sub>off</sub>    | Turn-Off Switching Loss           | —    | 0.08 | —    |       |                                                                                                                                                                                |
| E <sub>is</sub>     | Total Switching Loss              | —    | 0.14 | 0.2  | ns    | T <sub>J</sub> = 150°C,<br>I <sub>C</sub> = 6.5A, V <sub>CC</sub> = 480V<br>V <sub>GE</sub> = 15V, R <sub>G</sub> = 50Ω<br>Energy losses include "tail"<br>See Fig. 10, 11, 14 |
| t <sub>d(on)</sub>  | Turn-On Delay Time                | —    | 21   | —    |       |                                                                                                                                                                                |
| t <sub>r</sub>      | Rise Time                         | —    | 15   | —    |       |                                                                                                                                                                                |
| t <sub>d(off)</sub> | Turn-Off Delay Time               | —    | 150  | —    |       |                                                                                                                                                                                |
| t <sub>f</sub>      | Fall Time                         | —    | 150  | —    |       |                                                                                                                                                                                |
| E <sub>is</sub>     | Total Switching Loss              | —    | 0.34 | —    |       |                                                                                                                                                                                |
| L <sub>E</sub>      | Internal Emitter Inductance       | —    | 7.5  | —    | nH    | Measured 5mm from package                                                                                                                                                      |
| C <sub>ies</sub>    | Input Capacitance                 | —    | 490  | —    | pF    | V <sub>GE</sub> = 0V<br>V <sub>CC</sub> = 30V<br>f = 1.0MHz<br>See Fig. 7                                                                                                      |
| C <sub>oes</sub>    | Output Capacitance                | —    | 38   | —    |       |                                                                                                                                                                                |
| C <sub>res</sub>    | Reverse Transfer Capacitance      | —    | 8.8  | —    |       |                                                                                                                                                                                |

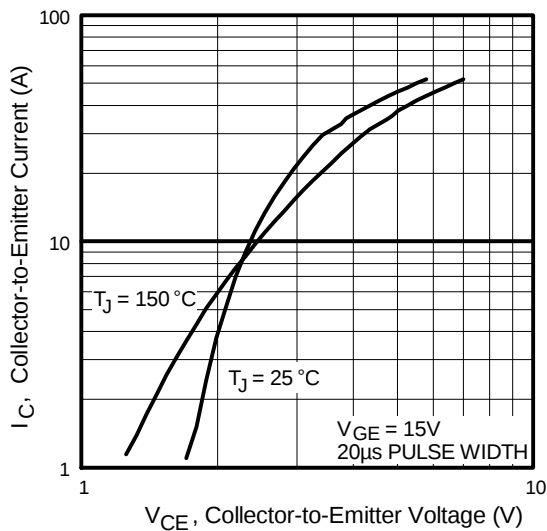
### Notes:

- ① Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature. ( See fig. 13b )
- ②  $V_{CC} = 80\%(V_{CES}), V_{GE} = 20V, L = 10\mu H, R_G = 50\Omega$ , (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.

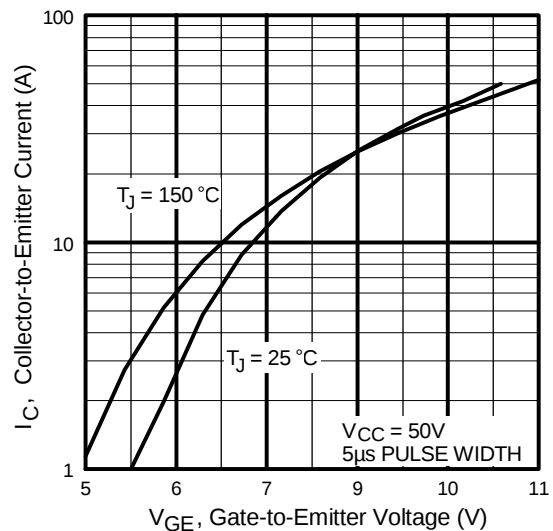
- ④ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ⑤ Pulse width  $5.0\mu s$ , single shot.
- ⑥  $t = 60s, f = 60Hz$



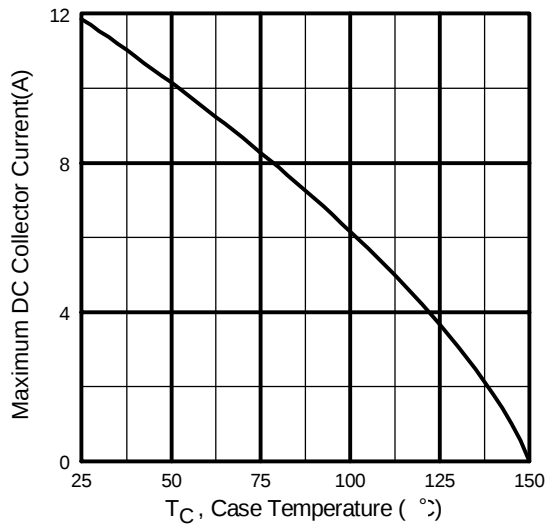
**Fig. 1 - Typical Load Current vs. Frequency**  
(Load Current =  $I_{RMS}$  of fundamental)



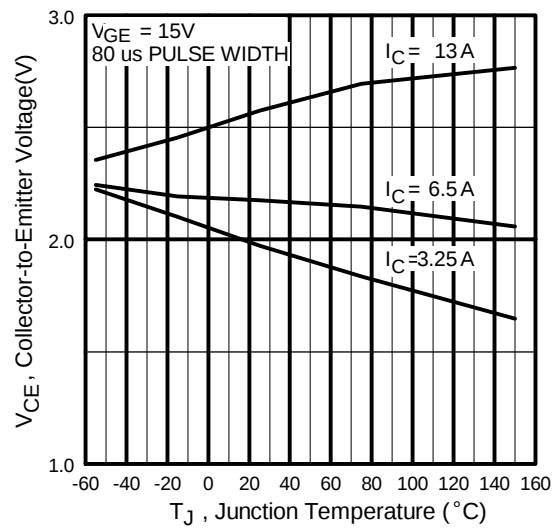
**Fig. 2 - Typical Output Characteristics**



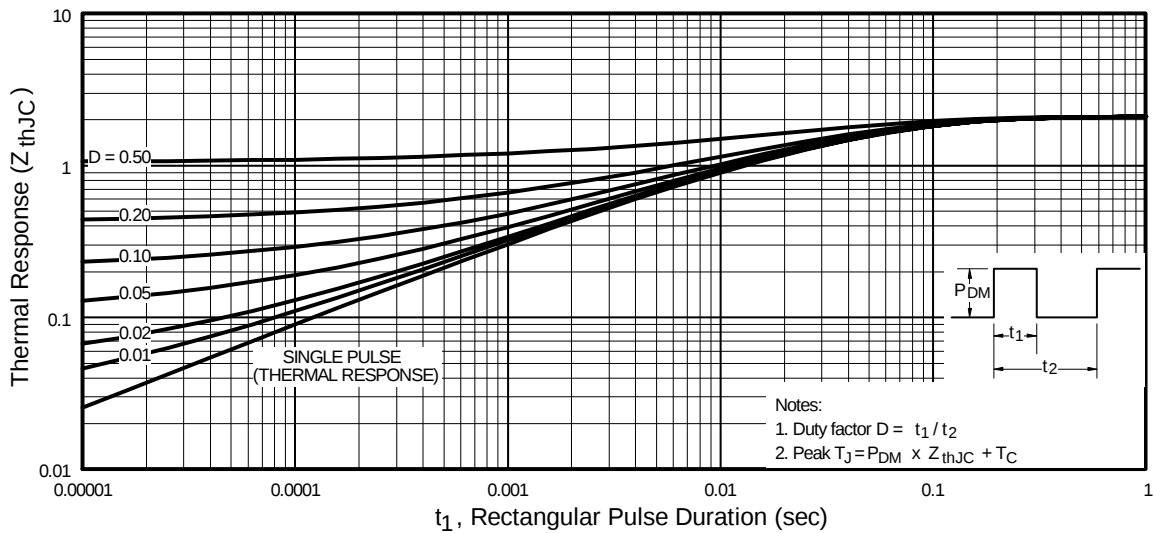
**Fig. 3 - Typical Transfer Characteristics**



**Fig. 4 - Maximum Collector Current vs. Case Temperature**

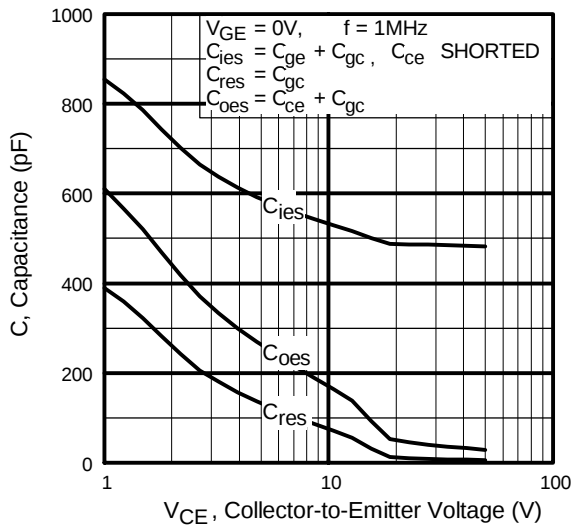


**Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature**

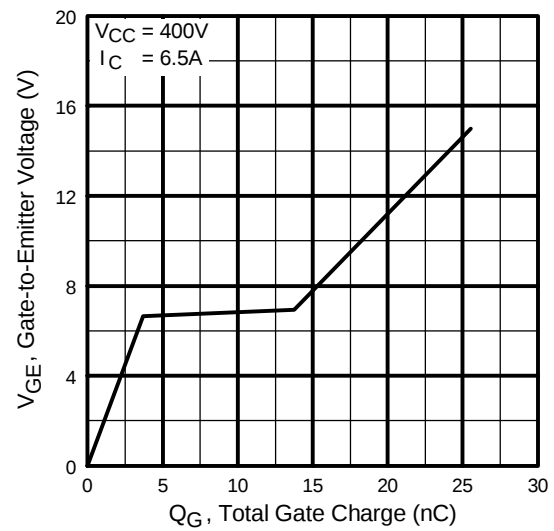


**Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**

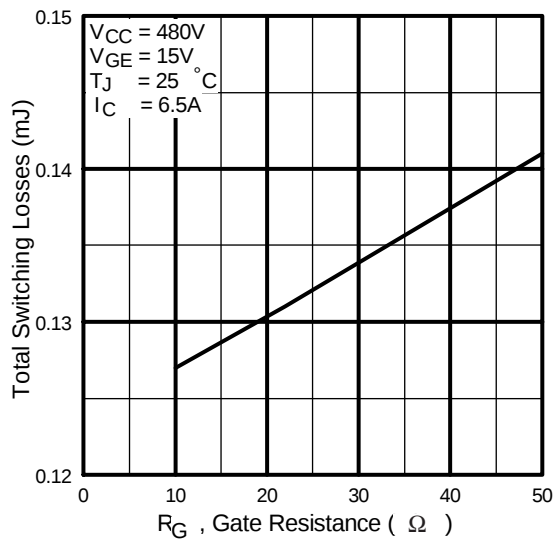
# IRG4IBC20WPbF



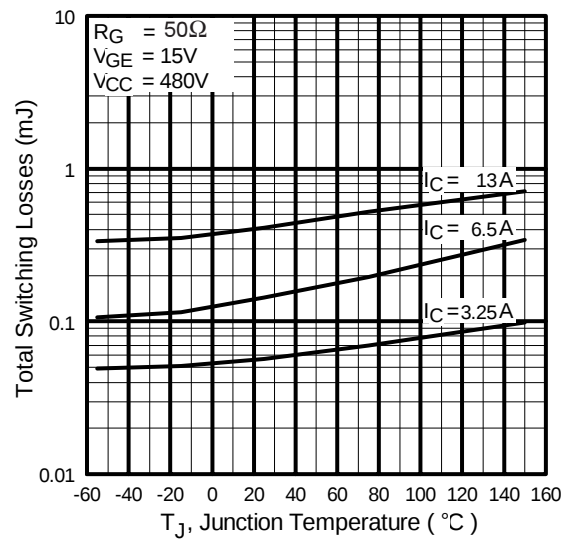
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage



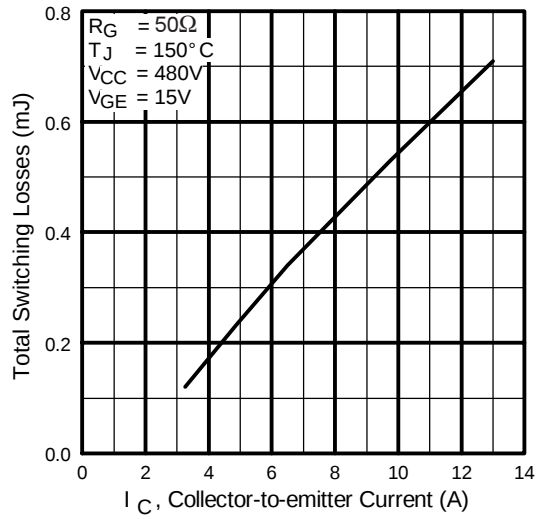
**Fig. 9** - Typical Switching Losses vs. Gate Resistance



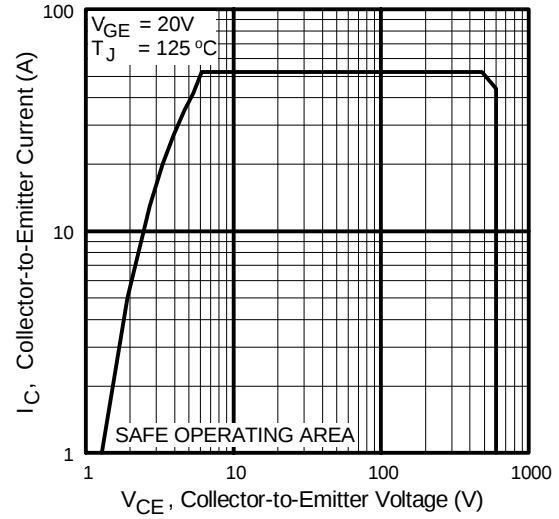
**Fig. 10** - Typical Switching Losses vs. Junction Temperature

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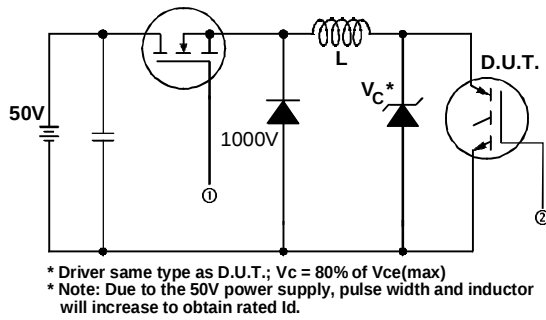
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**IR** Rectifier



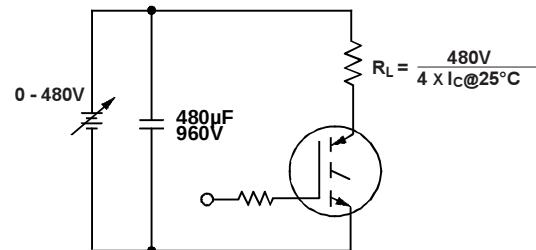
**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



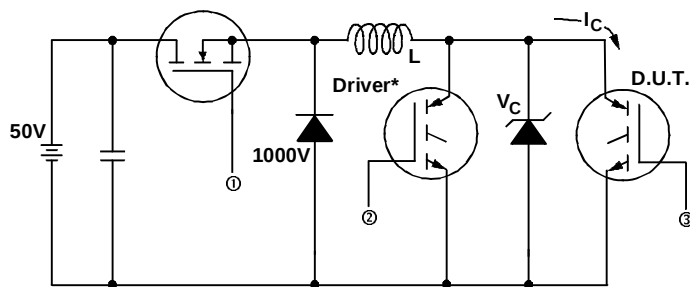
**Fig. 12** - Turn-Off SOA



**Fig. 13a** - Clamped Inductive Load Test Circuit

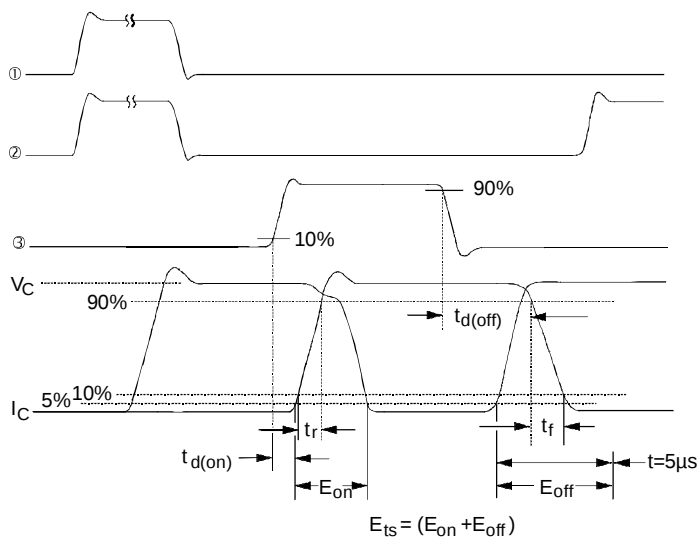


**Fig. 13b** - Pulsed Collector Current Test Circuit



**Fig. 14a** - Switching Loss Test Circuit

\* Driver same type as D.U.T.,  $V_C = 480V$



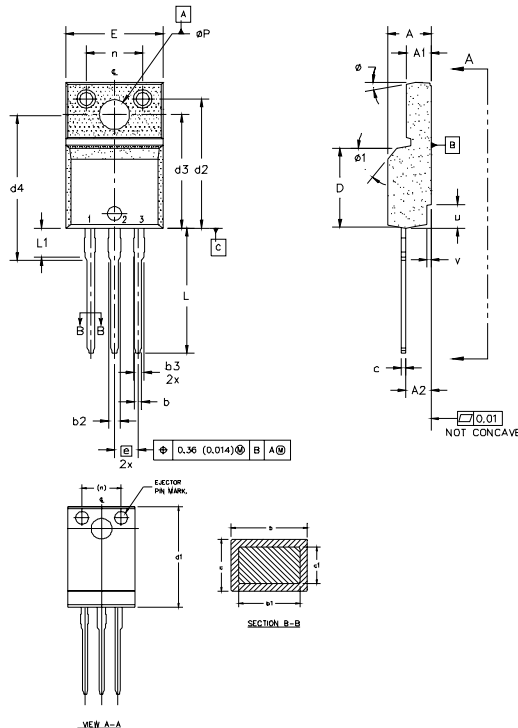
**Fig. 14b** - Switching Loss Waveforms

# IRG4IBC20WPbF

## TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)

International  
**IR** Rectifier



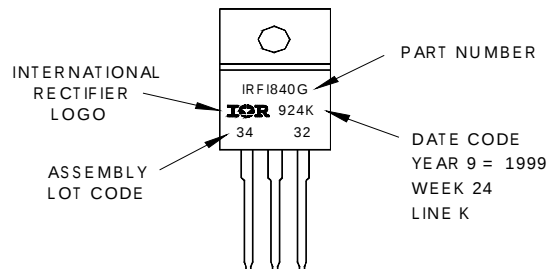
- NOTES:
- 1.0 DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994.
  - 2.0 DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
  - 3.0 LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.
  - 4.0 DIMENSION D & E DO NOT INCLUDE MOLD FLASH; MOLD FLASH SHALL NOT EXCEED 0.005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
  - 5.0 DIMENSION d1 APPLY TO BASE METAL ONLY.
  - 6.0 STEP OPTIONAL ON PLASTIC BODY DEFINED BY DIMENSIONS u & v.
  - 7.0 CONTROLLING DIMENSION : INCHES.

| DIMENSIONS |             |       |           |       |   | NOTES          | LEAD ASSIGNMENTS |
|------------|-------------|-------|-----------|-------|---|----------------|------------------|
| SYMBOL     | MILLIMETERS |       | INCHES    |       |   |                |                  |
|            | MIN.        | MAX.  | MIN.      | MAX.  |   |                |                  |
| A          | 4.57        | 4.83  | 0.180     | 0.190 |   |                |                  |
| A1         | 2.57        | 2.83  | 0.101     | 0.114 |   | HEXFET         |                  |
| A2         | 2.51        | 2.85  | 0.099     | 0.112 |   |                |                  |
| b          | 0.622       | 0.89  | 0.024     | 0.035 |   | 1. - GATE      |                  |
| b1         | 0.622       | 0.838 | 0.024     | 0.033 | 5 | 2. - DRAIN     |                  |
| b2         | 1.229       | 1.400 | 0.048     | 0.055 |   | 3. - SOURCE    |                  |
| b3         | 1.229       | 1.400 | 0.048     | 0.055 |   |                |                  |
| c          | 0.440       | 0.629 | 0.017     | 0.025 |   | IGBTs, CoPACK  |                  |
| c1         | 0.440       | 0.584 | 0.017     | 0.023 |   |                |                  |
| D          | 8.65        | 9.80  | 0.341     | 0.386 | 4 | 1. - GATE      |                  |
| d1         | 15.80       | 16.12 | 0.622     | 0.635 |   | 2. - COLLECTOR |                  |
| d2         | 13.97       | 14.22 | 0.550     | 0.560 |   | 3. - EMITTER   |                  |
| d3         | 12.30       | 12.92 | 0.484     | 0.509 |   |                |                  |
| d4         | 8.64        | 9.91  | 0.340     | 0.390 |   |                |                  |
| E          | 10.36       | 10.63 | 0.408     | 0.419 | 4 |                |                  |
| e          | 2.54 BSC    |       | 0.100 BSC |       |   |                |                  |
| L          | 13.20       | 13.73 | 0.520     | 0.541 |   |                |                  |
| L1         | 3.10        | 3.50  | 0.122     | 0.138 | 3 |                |                  |
| n          | 6.05        | 6.15  | 0.238     | 0.242 |   |                |                  |
| op         | 3.05        | 3.45  | 0.120     | 0.136 |   |                |                  |
| u          | 2.40        | 2.50  | 0.094     | 0.098 | 6 |                |                  |
| v          | 0.40        | 0.50  | 0.016     | 0.020 | 6 |                |                  |
| w          | 3"          | 7"    | 3"        | 7"    |   |                |                  |
| x          |             | 45"   |           | 45"   |   |                |                  |

## TO-220 Full-Pak Part Marking Information

EXAMPLE: THIS IS AN IRF1840G  
WITH ASSEMBLY  
LOT CODE 3432  
ASSEMBLED ON WW 24 1999  
IN THE ASSEMBLY LINE "K"

**Note:** "P" in assembly line  
position indicates "Lead-Free"



Data and specifications subject to change without notice.

International  
**IR** Rectifier

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TAC Fax: (310) 252-7903

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